

mXT448UD-CCUBHA1 1.0

maXTouch 448-node Touchscreen Controller Product Brief

Description

The mXT448UD-CCUBHA1 1.0 uses a unique charge-transfer acquisition engine to implement Microchip's patented capacitive sensing method. Coupled with a state-of-the-art CPU, the entire touchscreen sensing solution can measure, classify and track a number of individual finger touches with a high degree of accuracy in the shortest response time. The mXT448UD-CCUBHA1 1.0 allows for both mutual and self capacitance measurements, with the self capacitance measurements being used to augment the mutual capacitance measurements to produce reliable touch information.

Functional Safety

- UL/IEC 60730 Class B support
- Self diagnostics at power-on and as periodic tests during operation
- · Heartbeat (alive) signal output to host

maXTouch® Adaptive Sensing Technology

- Up to 32 X (transmit) lines and 20 Y (receive) lines for use by a touchscreen and/or key array
- A maximum of 448 nodes can be allocated to the touch sensor
- Touchscreen size of 8.3 inches (16:9 aspect ratio), assuming a sensor electrode pitch of 6.5 mm. Other sizes are possible with different electrode pitches and appropriate sensor material
- Multiple touch support with up to 16 concurrent touches tracked in real time

Keys

- Up to 32 nodes can be allocated as mutual capacitance sensor keys in addition to the touchscreen, defined as 1 key array (subject to availability of X and Y lines and other configurations)
- Support for up to 3 mutual capacitance Generic Keys as an alternative to the touchscreen key array (subject to other configurations)
- Adjacent Key Suppression (AKS) technology is supported for false key touch prevention

Touch Sensor Technology

- Discrete/out-cell support including glass and PET filmbased sensors
- On-cell/touch-on display support including TFT, LCD (ITPS, IPS) and OLED
- · Synchronization with display refresh timing capability
- Support for standard (for example, Diamond) and proprietary sensor patterns (review of designs by Microchip or a Microchip-qualified touch sensor module partner is recommended)

Front Panel Material and Design

- Works with PET or glass, including curved profiles (configuration and stack-up to be approved by Microchip or a Microchip-qualified touch sensor module partner)
- 10 mm glass (or 5 mm PMMA) with bare finger (dependent on sensor size, touch size, configuration and stack-up)
- 6 mm glass (or 3 mm PMMA) with multi-finger 5 mm glove (2.7 mm PMMA equivalent) (dependent on sensor size, touch size, configuration and stack-up)
- Support for non-rectangular sensor designs (for example, circular, rounded or with cutouts)

Touch Performance

- Moisture/Water Compensation
 - No false touch with condensation or water drop up to 22 mm diameter
 - One-finger tracking with condensation or water drop up to 22 mm diameter
- Mutual capacitance and self capacitance measurements supported for robust touch detection
- P2P mutual capacitance measurements supported for extra sensitive multi-touch sensing
- Noise suppression technology to combat ambient and power-line noise
 - Up to 240 V_{PP} between 1 Hz and 1 kHz sinusoidal waveform (no touches)
 - IEC 61000-4-6, 10 Vrms, Class A (normal touch operation) conducted noise immunity
- · Stylus Support
 - Supports passive stylus with 1.5 mm contact diameter, subject to configuration, stack-up, and sensor design

- · Burst Frequency
 - Flexible and dynamic Tx burst frequency selection to reduce EMC disturbance
 - Configurable Tx waveform shaping to reduce emissions
- Scan Speed
 - Typical report rate for 10 touches ≥90 Hz (subject to configuration)
 - Initial touch latency <25 ms for first touch from idle (subject to configuration)
 - Configurable to allow for power and speed optimization

On-chip Gestures

· Reports one-touch and two-touch gestures

Enhanced Algorithms

- · Lens bending algorithms to remove display noise
- · Touch suppression algorithms to remove unintentional large touches, such as palm
- Palm Recovery Algorithm for quick restoration to normal state

Data Store

• Up to 64 bytes of user's custom data (not CRC checksummed)

Power Saving

- · Programmable timeout for automatic transition from Active to Idle state
- Pipelined analog sensing detection and digital processing to optimize system power efficiency

Application Interfaces

- 1²C client interface for main communication with the device, with support for Standard mode (up to 100 kHz), Fast mode (up to 400 kHz), Fast-mode Plus (up to 1 MHz), High Speed mode (up to 3.4 MHz)
- Optional secondary SPI interface for separate messaging (up to 8 MHz)
- Two separate interrupts to indicate when messages are available on the corresponding interfaces
- Additional Hardware Debug Interface to read the raw data for tuning and debugging purposes

Power Supply

- Digital (Vdd) 3.3V nominal
- Digital I/O (VddIO) 3.3V nominal
- Analog (AVdd) 3.3V nominal
- High voltage internal X line drive (XVdd) 6.6V or 9.9V with internal voltage pump

Package

• 88-ball UFBGA 6 × 6 × 0.6 mm, 0.5 mm pitch

Operating Temperature

–40°C to +105°C

Design Services

· Review of device configuration, stack-up and sensor patterns

PIN CONFIGURATION

88-ball UFBGA

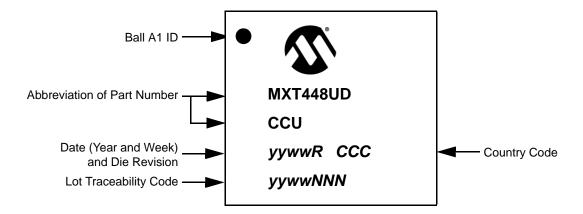
,	1	2	3	4	5	6	7	8	9	10	11
Α	AVDD	O DS0	O Y18	О У16	O Y14		○ Y8	Уб	O Y4	O Y2	O Y O
В	X18		Y19	O Y17	Y15		O Y7	O Y5	<u>у</u> 3		AVDD
С	X20	X19		GND	Y13		Y9	<u>у</u> 1		X0	<u>х</u> 1
D	X22	O X21	X17		O Y12	O Y11	○ Y10		GND	O x2	О хз
E	X24	X23	X25	X26				O x7	X6	X4	X5
F				X27				X8			
G	X30	X31	X29	X28				Х9	X10	X12	O X11
Н	RESV	RESV	EXTCAP1		SCK	○ TEST	CHG_I2C		GND	X14	X13
J	EXTCAP0	EXTCAP3		GND	$\bigcup_{\underline{s}\underline{s}}$		RESV	MOSI		X16	X15
Κ	EXTCAP2		VDDIO	RESET	MISO		CHG_SPI	DBG_DATA GPIO2	GKEYY2		GKEYX0
L	XVDD	VDD	VDDCORE	SCL	SDA		SYNC GPI00	DBG_CLK GPIO1	GKEYY1	GKEYY0	XVDD

Top View

1.0 PACKAGING INFORMATION

1.1 Package Marking Information

1.1.1 88-BALL UFBGA



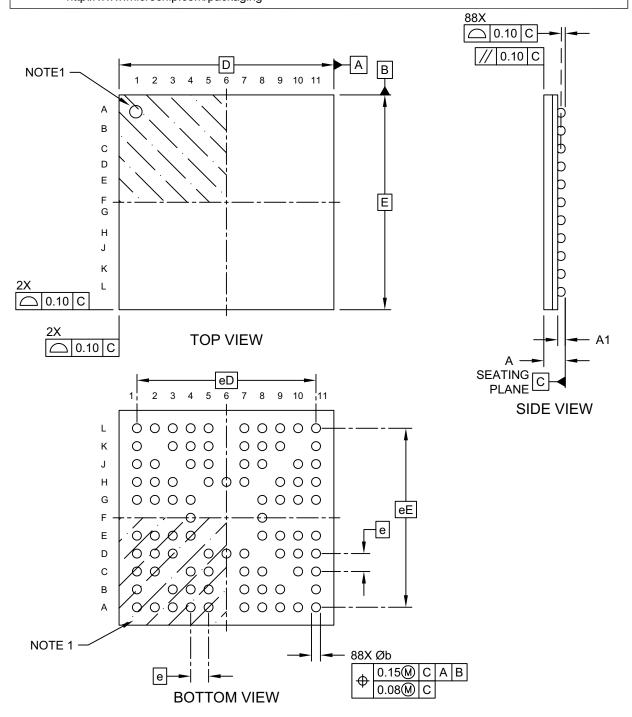
1.1.2 ORDERABLE PART NUMBERS

The product identification system for maXTouch devices is described in "Product Identification System" on page 9. That section also lists example part numbers for the device.

1.2 Package Details

88-Ball Ultra Thin Fine Pitch Ball Grid Array (BVB) - 6x6x0.6 mm Body [UFBGA] Atmel Legacy Global Package Code CJM

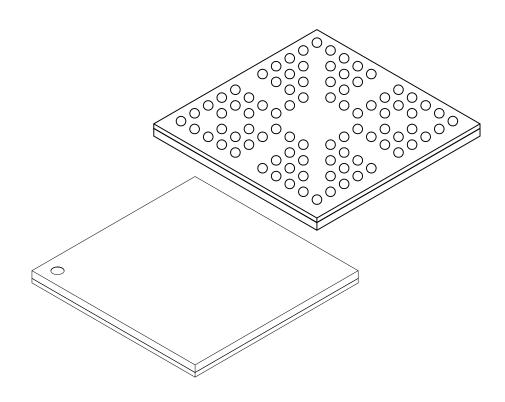
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-21158 Rev A Sheet 1 of 2

88-Ball Ultra Thin Fine Pitch Ball Grid Array (BVB) - 6x6x0.6 mm Body [UFBGA] Atmel Legacy Global Package Code CJM

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS				
Dimension	MIN	NOM	MAX		
Number of Terminals	Ν	88			
Pitch	е	0.50 BSC			
Overall Terminal Spacing	eD		5.00 BSC		
Overall Terminal Spacing	еE		5.00 BSC		
Overall Height	Α	-	_	0.60	
Standoff	A1	0.11	_	0.21	
Overall Length	D	6.00 BSC			
Overall Width	Е	6.00 BSC			
Terminal Diameter	b	0.22	0.25	0.28	

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Dimensioning and tolerancing per ASME Y14.5M

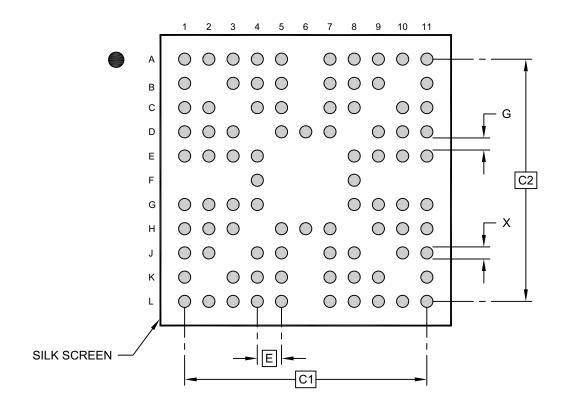
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-21158 Rev A Sheet 2 of 2

88-Ball Ultra Thin Fine Pitch Ball Grid Array (BVB) - 6x6x0.6 mm Body [UFBGA] Atmel Legacy Global Package Code CJM

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	MILLIMETERS				
Dimension	Limits	MIN	NOM	MAX	
Contact Pitch	Е		0.50 BSC		
Overall Contact Pitch	C1		5.00 BSC		
Overall Contact Pitch	C2		5.00 BSC		
Contact Pad Diameter	Х			0.28	
Contact Pad to Contact Pad	G	0.25			

Notes:

- Dimensioning and tolerancing per ASME Y14.5M

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 - BSC: Basic Dimension. Theoretically exact value shown without tolerances.

 best soldering results, thermal vias, if used, should be filled or tented to avoid sold.
- For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-23158 Rev A

mXT448UD-CCUBHA1 1.0

APPENDIX A: REVISION HISTORY

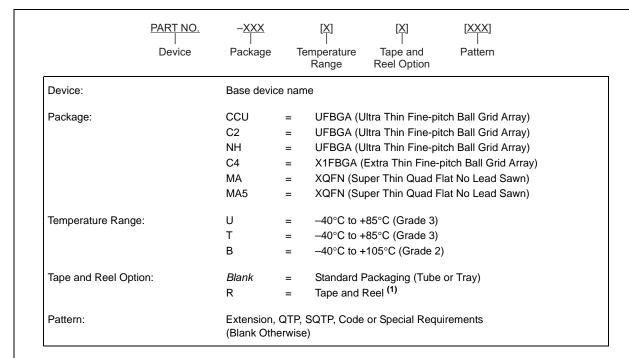
Revision A (September 2021)

Initial edition for firmware revision 1.0.AA – Release

PRODUCT IDENTIFICATION SYSTEM

The table below gives details on the product identification system for maXTouch devices. See "Orderable Part Numbers" below for example part numbers for the mXT448UD-CCUBHA1.

To order or obtain information, for example on pricing or delivery, refer to the factory or the listed sales office.



Note 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. See "Orderable Part Numbers" below or check with your Microchip Sales Office for package availability with the Tape and Reel option.

Orderable Part Numbers

Orderable Part Number	Firmware Revision	Description
ATMXT448UD-CCUBHA1 (Supplied in trays)	1.0.AA	88-ball UFBGA 6 × 6 × 0.6 mm, RoHS compliant
ATMXT448UD-CCUBRHA1 (Supplied in tape and reel)		

mXT448UD-CCUBHA1 1.0

NOTES:

Note the following details of the code protection feature on Microchip products:

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Corporate Office 2355 West Chandler Blvd.

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